

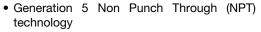
INT-A-PAK "Half Bridge" (Ultrafast Speed IGBT), 209 A



INT-A-PAK

PRIMARY CHARACTERISTICS				
V _{CES}	600 V			
I _C DC	209 A			
V _{CE(on)} at 200 A, 25 °C	2.6 V			
Speed	8 kHz to 30 kHz			
Package	INT-A-PAK			
Circuit configuration	Half bridge with SMD gate resistor			

FEATURES





• Ultrafast: optimized for hard switching speed

ROHS COMPLIANT

- Low V_{CE(on)}
- 10 µs short circuit capability
- Square RBSOA
- Positive V_{CE(on)} temperature coefficient
- HEXFRED® antiparallel diode with ultrasoft reverse recovery characteristics
- · Industry standard package
- Al₂O₃ DBC
- UL approved file E78996
- Designed for industrial level
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

BENEFITS

- Benchmark efficiency for UPS and welding application
- · Rugged transient performance
- Direct mounting on heatsink
- · Very low junction to case thermal resistance

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS		
Collector to emitter voltage	V _{CES}		600	V		
Ocalica canada da canada		T _C = 25 °C	209			
Continuous collector current	I _C	T _C = 80 °C	142			
Pulsed collector current	I _{CM}		400	Α		
Clamped inductive load current	I _{LM}		400			
Diode continuous forward current	I _F	T _C = 25 °C	178			
		T _C = 80 °C	121			
Gate to emitter voltage	V _{GE}		± 20	V		
Maximum power dissipation	D	T _C = 25 °C	781	W		
	P_D	T _C = 80 °C	438	VV		
Isolation voltage	V _{ISOL}	Any terminal to case, t = 1 min	2500	V		
Operating junction temperature range	T _J		-40 to +150	°C		





ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Collector to emitter breakdown voltage	V _{BR(CES)}	V _{GE} = 0 V, I _C = 500 μA	600	-	-		
	V _{CE(on)}	V _{GE} = 15 V, I _C = 100 A	-	1.95	2.1	V	
Collector to amittar valtage		$V_{GE} = 15 \text{ V}, I_{C} = 200 \text{ A}$	-	2.6	2.84		
Collector to emitter voltage		V _{GE} = 15 V, I _C = 100 A, T _J = 125 °C	-	2.28	2.5		
		$V_{GE} = 15 \text{ V}, I_{C} = 200 \text{ A}, T_{J} = 125 ^{\circ}\text{C}$	-	3.14	3.48		
Gate threshold voltage	V _{GE(th)}	$V_{CE} = V_{GE}$, $I_C = 500 \mu A$	3	4.2	6		
Collector to emitter leakage current	I _{CES}	$V_{GE} = 0 \text{ V}, V_{CE} = 600 \text{ V}$	-	0.005	0.2	mA	
		V_{GE} = 0 V, V_{CE} = 600 V, T_{J} = 150 °C	-	0.01	15	IIIA	
Diode forward voltage drop	V _{FM}	I _C = 100 A	-	1.39	1.78	V	
		I _C = 200 A	-	1.64	2.2		
		I _C = 100 A, T _J = 125 °C	-	1.32	1.69		
		I _C = 200 A, T _J = 125 °C	-	1.67	2.30		
Gate to emitter leakage current	I _{GES}	V _{GE} = ± 20 V	-	-	± 200	nA	

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Turn-on switching loss	E _{on}		-	3.65	-		
Turn-off switching loss	E _{off}	$I_C = 200 \text{ A}, V_{CC} = 360 \text{ V}, V_{GE} = 15 \text{ V}, R_g = 10 \Omega, L = 200 \mu\text{H}, T_J = 25 °\text{C}$	-	6.9	-		
Total switching loss	E _{tot}	· · · · · · · · · · · · · · · · · · ·	-	10.55	-	1	
Turn-on switching loss	E _{on}		-	3.8	-	mJ	
Turn-off switching loss	E _{off}		-	7.8	-	1	
Total switching loss	E _{tot}		-	11.6	-		
Turn-on delay time	t _{d(on)}	$I_C = 200 \text{ A}, V_{CC} = 360 \text{ V}, V_{GE} = 15 \text{ V}, R_q = 10 \Omega, L = 200 \mu\text{H}, T_J = 125 °\text{C}$	-	507	-		
Rise time	t _r	· · · · · · · · · · · · · · · · · · ·	-	133	-		
Turn-off delay time	t _{d(off)}		-	538	-	ns	
Fall time	t _f		-	92	-		
Reverse bias safe operating area	RBSOA	$T_J = 150 ^{\circ}\text{C}, \ I_C = 400 \text{A}, \ R_g = 27 \Omega, \ V_{GE} = 15 \text{V to } 0$	Fullsquare				
Short circuit safe operating area	SCSOA	$\begin{split} T_J &= 150~^{\circ}\text{C}, \ V_{CC} = 400~\text{V}, \ V_P = 600~\text{V}, \\ R_g &= 27~\Omega, \ V_{GE} = 15~\text{V to 0} \end{split}$	10	-	-		
Diode reverse recovery time	t _{rr}		-	226	260	ns	
Diode peak reverse current	I _{rr}	I _F = 50 A, dI _F /dt = 200 A/μs, V _{CC} = 400 V, T _J = 25 °C	-	17	20	Α	
Diode recovery charge	Q _{rr}	, ,	-	1900	2600	nC	
Diode reverse recovery time	t _{rr}		-	290	330	ns	
Diode peak reverse current	I _{rr}	I _F = 50 A, dI _F /dt = 200 A/μs, V _{CC} = 400 V, T _J = 125 °C	-	25	30	Α	
Diode recovery charge	Q _{rr}		-	3600	5000	nC	



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THERMAL AND MECHANICAL SPECIFICATIONS							
PARAMETER		SYMBOL	MIN.	TYP.	MAX.	UNITS	
Operating junction and storage temperature range		T _J , T _{Stg}	-40	-	150	°C	
Junction to case per leg	IGBT	R _{thJC}	-	0.13	0.16	°C/W	
	Diode		-	0.19	0.32		
Case to sink per module		R _{thCS}	-	0.1	-	1	
Mounting torque	case to heatsink		-	-	4	Nm	
	case to terminal 1, 2, 3		-	-	3		
Weight			-	185	-	g	

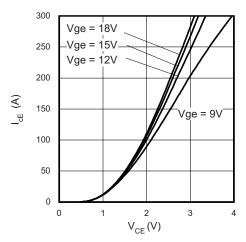


Fig. 1 - Typical IGBT Output Characteristics $T_J = 25~^{\circ}\text{C},\, t_p = 500~\mu\text{s}$

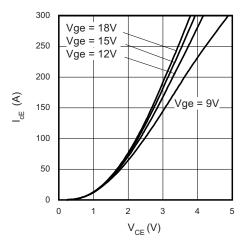


Fig. 2 - Typical IGBT Output Characteristics $T_J = 125~^{\circ}\text{C},\, t_p = 500~\mu\text{s}$

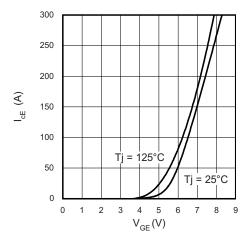


Fig. 3 - Typical Transfer Characteristics $V_{CE} = 20 \text{ V}, \, t_p = 500 \, \mu \text{s}$

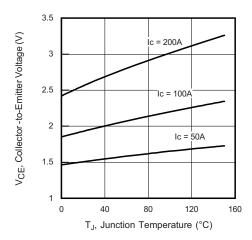


Fig. 4 - Typical Collector to Emitter Voltage vs. Junction Temperature

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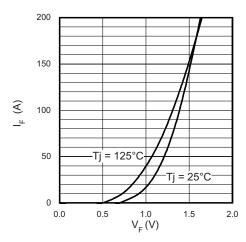


Fig. 5 - Diode Forward Characteristics, $t_p = 500 \ \mu s$

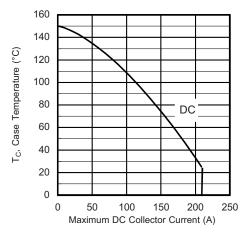


Fig. 6 - Maximum Collector Current vs. Case Temperature

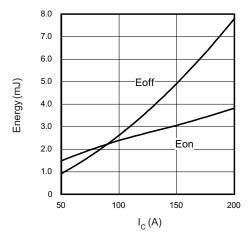


Fig. 7 - Typical Energy Loss vs. I_C T_J = 125 °C, L = 200 μ H, V_{CC} = 360 V, R_q = 10 Ω , V_{GE} = 15 V

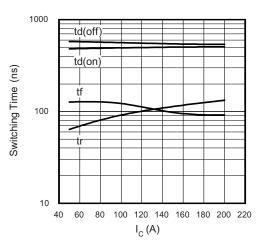
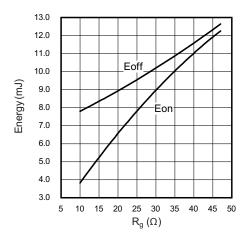


Fig. 8 - Typical Switching Time vs. I_C T_J = 125 °C, L = 200 μ H, V_{CC} = 360 V, R_g = 10 Ω , V_{GE} = 15 V



 $\begin{aligned} &\text{Fig. 9 - Typical Energy Loss vs. R}_g \\ &\text{T}_J = 125~^{\circ}\text{C}, \ L = 200~\mu\text{H}, \ V_{CC} = 360~\text{V}, \\ &\text{I}_{CE} = 200~\text{A}, \ V_{GE} = 15~\text{V} \end{aligned}$

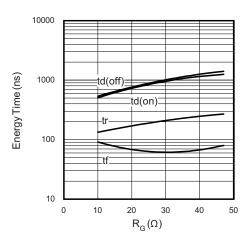


Fig. 10 - Typical Switching Time vs. R_g $T_J = 125$ °C, $L = 200~\mu H, V_{CC} = 360~V,$ $I_{CE} = 200~A, V_{GE} = 15~V$

40

80

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100 90 80 70 60 27 ohm 47 ohm 30 20

Fig. 11 - Typical Diode I_{rr} vs. I_F $T_J = 125 \, ^{\circ}C$

120

 $I_F(A)$

160

200

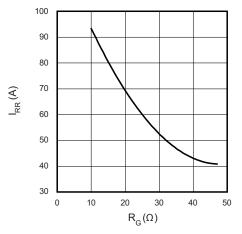


Fig. 12 - Typical Diode I_{rr} vs. R_g $T_J = 125~^{\circ}C, I_F = 200~A$

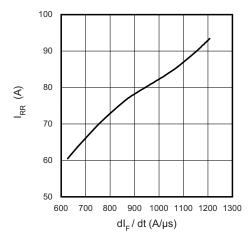


Fig. 13 - Typical Diode I_{rr} vs. dI_F/dt T_J = 125 °C, V_{CC} = 360 V, I_F = 200 A, V_{GE} = 15 V

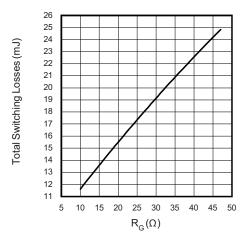


Fig. 14 - Typical Switching Losses vs. Gate Resistance T_J = 125 °C, L = 200 μ H, R_g = 10 Ω , V_{CC} = 360 V, V_{GE} = 15 V

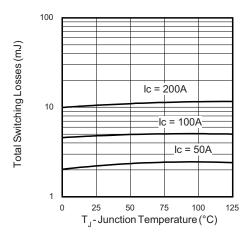
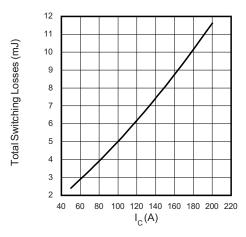


Fig. 15 - Typical Switching Losses vs. Junction Temperature; L = 200 μ H, R_q = 10 Ω , V_{CC} = 360 V, V_{GE} = 15 V



 $\label{eq:fig:sigma} Fig.~16 - Typical Switching Losses vs. \\ Collector to Emitter Current; \\ T_J = 125 \ ^{\circ}C, R_{g1} = 10 \ \Omega, \ R_{g2} = 0 \ \Omega, \ V_{CC} = 360 \ V, \ V_{GE} = 15 \ V \\ \end{array}$



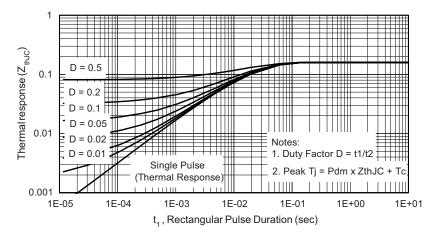


Fig. 17 - Maximum Transient Thermal Impedance, Junction to Case (IGBT)

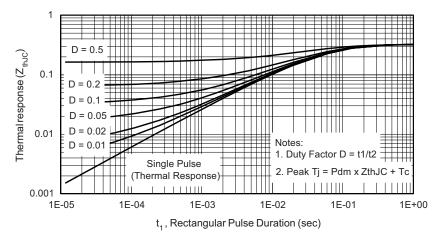
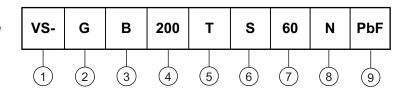


Fig. 18 - Maximum Transient Thermal Impedance, Junction to Case (HEXFRED®)

ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

- Insulated gate bipolar transistor (IGBT)

B = IGBT Gen 5 NPT

4 - Current rating (200 = 200 A)

- Circuit configuration (T = half bridge)

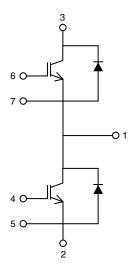
- Package indicator (S = INT-A-PAK)

7 - Voltage rating (60 = 600 V)

8 - Speed / type (N = ultrafast IGBT)

9 - Lead (Pb)-free

CIRCUIT CONFIGURATION

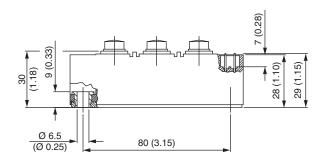


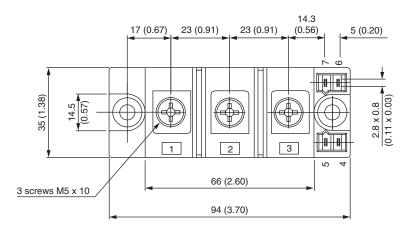
LINKS TO RELAT	ED DOCUMENTS
Dimensions	www.vishay.com/doc?95543

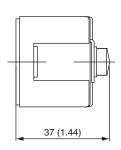


INT-A-PAK IGBT

DIMENSIONS in millimeters (inches)









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